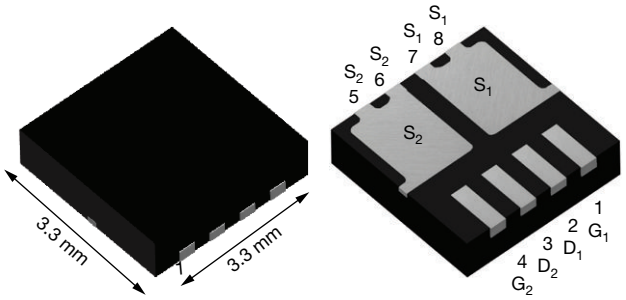
Common Drain Dual N-Channel 30 V (S1-S2) MOSFET

PowerPAK® 1212-8SCD



Top View Bottom View

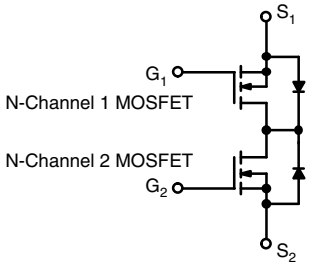
FEATURES

- TrenchFET® Gen IV power MOSFET
- Very low source-to-source on resistance
- Integrated common-drain n-channel MOSFETs in a compact and thermally enhanced package
- 100 % R_g and UIS tested
- Optimizes circuit layout for bi-directional current flow
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Battery management
- Load switching



PRODUCT SUMMARY	
V_{S1S2} (V)	30
$R_{S1S2(on)}$ max. (Ω) at V_{GS} = 10 V	0.005
$R_{S1S2(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.007
Q_g typ. (nC)	16.1 [h]
I_{S1S2} (A)	60 [a, g]
Configuration	Common drain

ORDERING INFORMATION	
Package	PowerPAK 1212-8SCD
Lead (Pb)-free and halogen-free	SiSF00DN-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{S1S2}	30	V
Gate-source voltage		V_{GS}	+20 / -16	
Continuous drain current (T_J = 150 °C)	T_C = 25 °C	I_{S1S2}	60 [a]	A
	T_C = 70 °C		60 [a]	
	T_A = 25 °C		25.5 [b, c]	
	T_A = 70 °C		20.4 [b, c]	
Pulsed drain current (t = 100 µs)		I_{S1S2M}	120	
Maximum power dissipation	T_C = 25 °C	P_D	69.4	W
	T_C = 70 °C		44.4	
	T_A = 25 °C		5.2 [b, c]	
	T_A = 70 °C		3.3 [b, c]	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) [c]			260	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient [b]	t ≤ 10 s	R_{thJA}	19	24	°C/W
Maximum junction-to-case (drain)	Steady state	R_{thJC}	1.4	1.8	

Notes

a. Package limited
b. Surface mounted on 1" x 1" FR4 board
c. t = 10 s
d. See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8SCD is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
f. Maximum under steady state conditions is 63 °C/W
g. T_C = 25 °C
h. Single MOSFET

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA	30	-	-	V
Gate-source threshold voltage	$V_{GS(th)}$	V_{S1S2} = V_{GS}, I_D = 250 µA	1	-	2.1	
Gate-source leakage	I_{GSS}	V_{S1S2} = 0 V, V_{GS} = +20 / -16 V	-	-	100	nA
Zero gate voltage drain current	I_{DSS}	V_{S1S2} = 30 V, V_{GS} = 0 V	-	-	1	µA
		V_{S1S2} = 30 V, V_{GS} = 0 V, T_J = 70 °C	-	-	15	
On-state drain current [a]	$I_{S1S2(on)}$	V_{S1S2} ≥ 10 V, V_{GS} = 10 V	20	-	-	A
Drain-source on-state resistance [a]	$R_{S1S2(on)}$	V_{GS} = 10 V, I_{S1S2} = 10 A	-	0.0042	0.0050	Ω
		V_{GS} = 4.5 V, I_{S1S2} = 5 A	-	0.0056	0.0070	
Forward transconductance [a]	g_{fs}	V_{S1S2} = 15 V, I_{S1S2} = 20 A	-	130	-	S
Dynamic [b, c]						
Input capacitance	C_{iss}	V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz	-	2700	-	pF
Output capacitance	C_{oss}		-	865	-	
Reverse transfer capacitance	C_{rss}		-	51	-	
Total gate charge	Q_g	V_{DS} = 15 V, V_{GS} = 10 V, I_D =10 A	-	35	53	nC
		V_{DS} = 15 V, V_{GS} = 4.5 V, I_D = 10 A	-	16.1	24.2	
Gate-source charge	Q_{gs}		-	7	-	
Gate-drain charge	Q_{gd}		-	2.5	-	
Gate resistance	R_g	f = 1 MHz	0.3	1.5	3	Ω
Turn-on delay time	$t_{d(on)}$	V_{DD} = 15 V, R_L = 1 Ω, I_{S1S2} ≅ 10 A, V_{GEN} = 10 V, R_g = 1 Ω	-	10	20	ns
Rise time	t_r		-	32	65	
Turn-off delay time	$t_{d(off)}$		-	22	45	
Fall time	t_f		-	10	20	
Turn-on delay time	$t_{d(on)}$	V_{DD} = 15 V, R_L = 1 Ω, I_D ≅ 10 A, V_{GEN} = 4.5 V, R_g = 1 Ω	-	21	45	
Rise time	t_r		-	60	120	
Turn-off delay time	$t_{d(off)}$		-	25	50	
Fall time	t_f		-	15	30	
Drain-Source Body Diode Characteristics [c]						
Continuous source-drain diode current	I_{S1S2}	T_C = 25 °C	-	-	60	A
Pulse diode forward current	I_{S1S2M}		-	-	120	
Body diode reverse recovery time	t_{rr}	I_F = 10 A, di/dt = 100 A/µs, T_J = 25 °C	-	42	85	ns
Body diode reverse recovery charge	Q_{rr}		-	42	85	nC
Reverse recovery fall time	t_a		-	23	-	ns
Reverse recovery rise time	t_b		-	19	-	

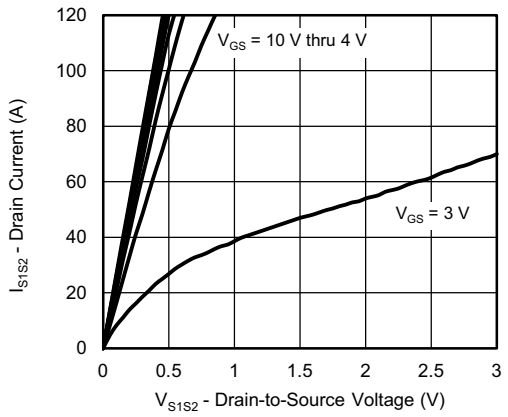
Notes

a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
b. Guaranteed by design, not subject to production testing
c. On single MOSFET

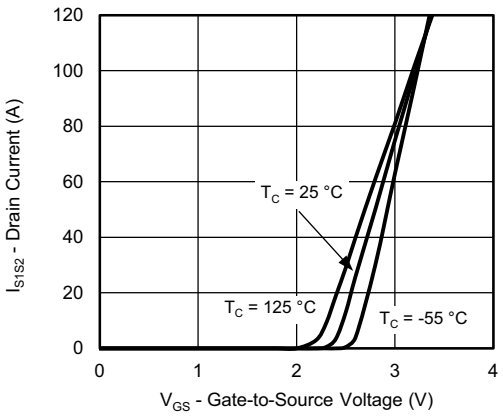
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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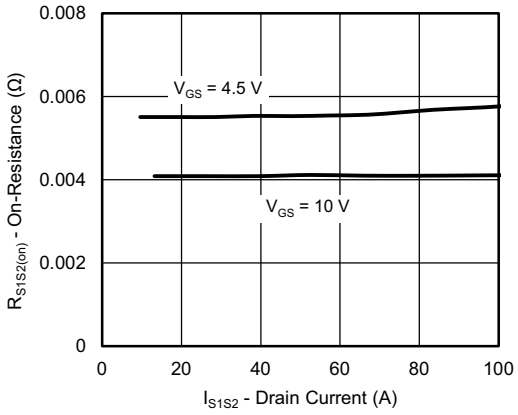
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



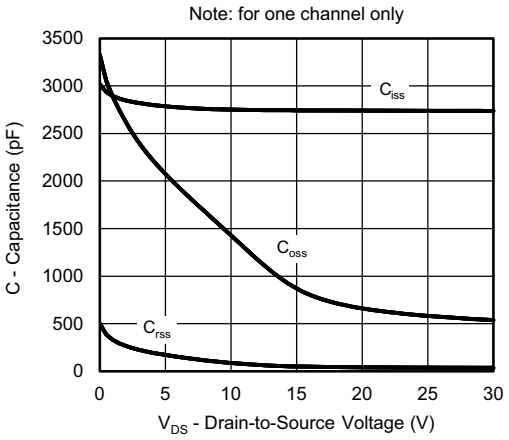
Output Characteristics



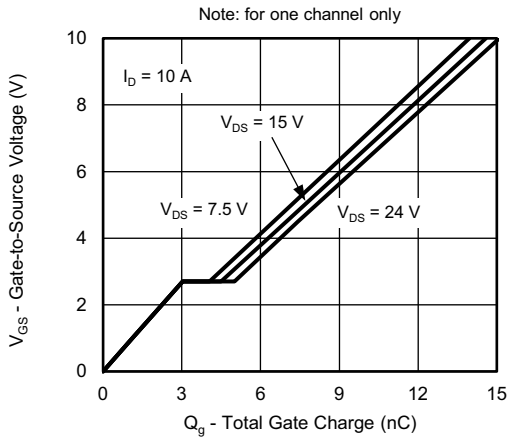
Transfer Characteristics



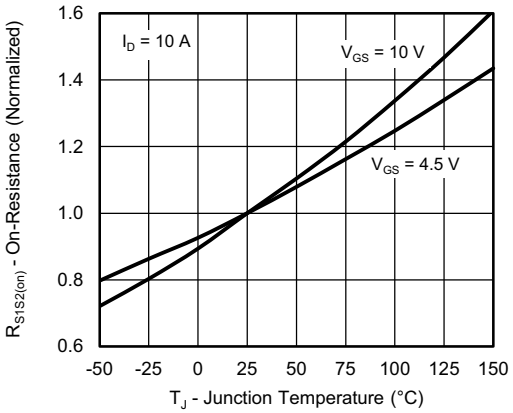
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



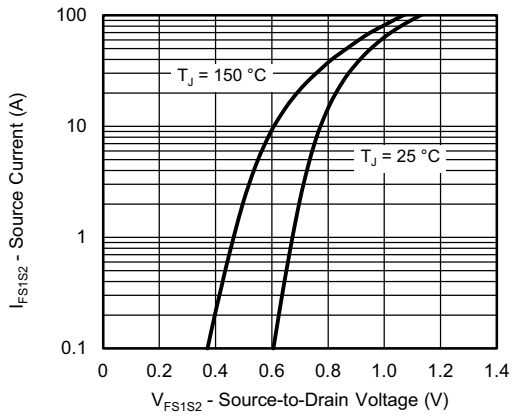
Gate Charge



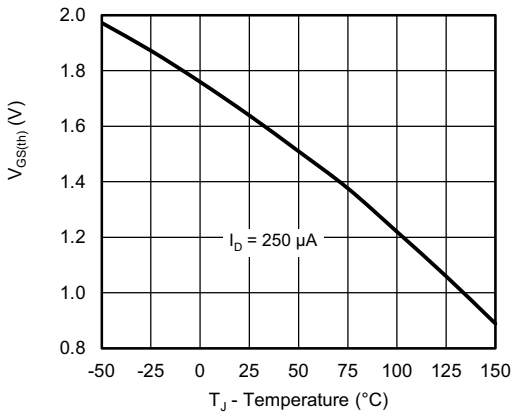
On-Resistance vs. Junction Temperature

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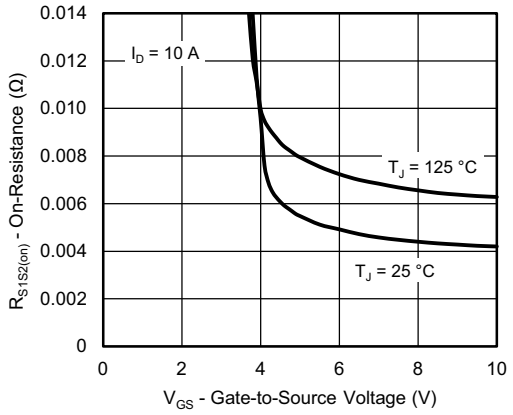
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



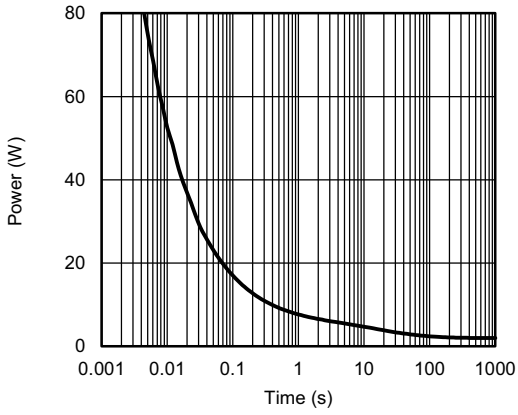
Source-Drain Diode Forward Voltage



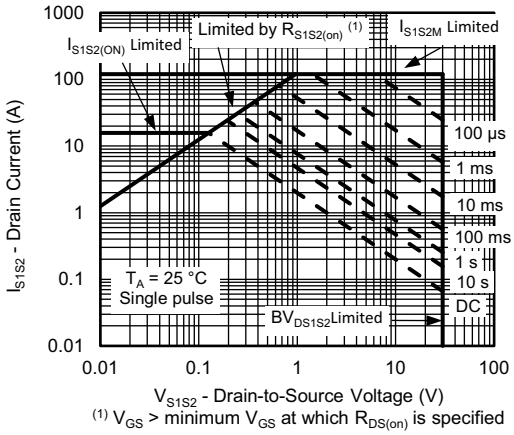
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



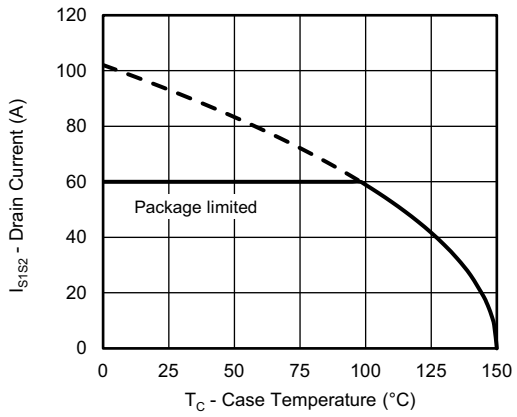
Single Pulse Power, Junction-to-Ambient



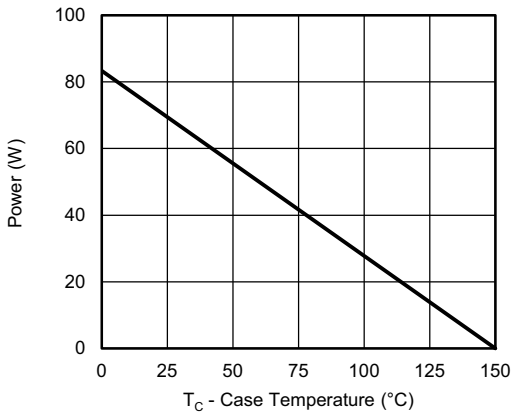
Safe Operating Area, Junction-to-Ambient

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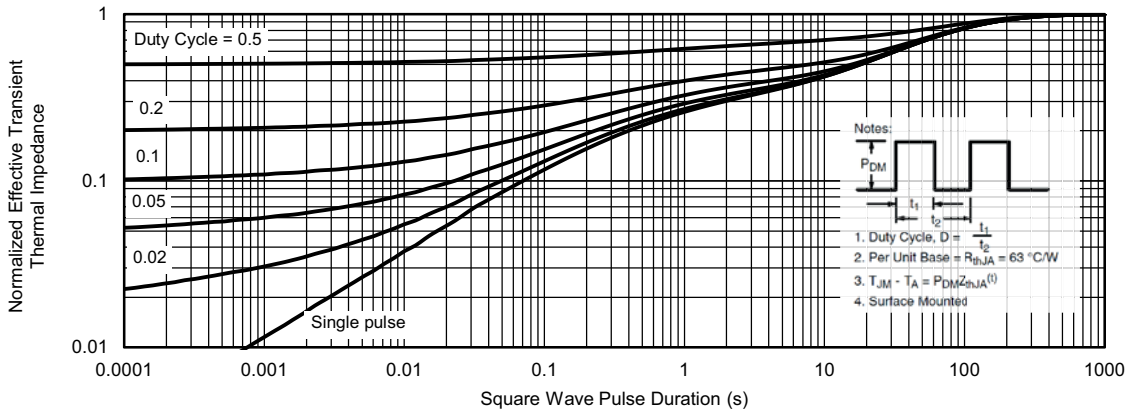
Current Derating [a]



Power, Junction-to-Case (Drain)

Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

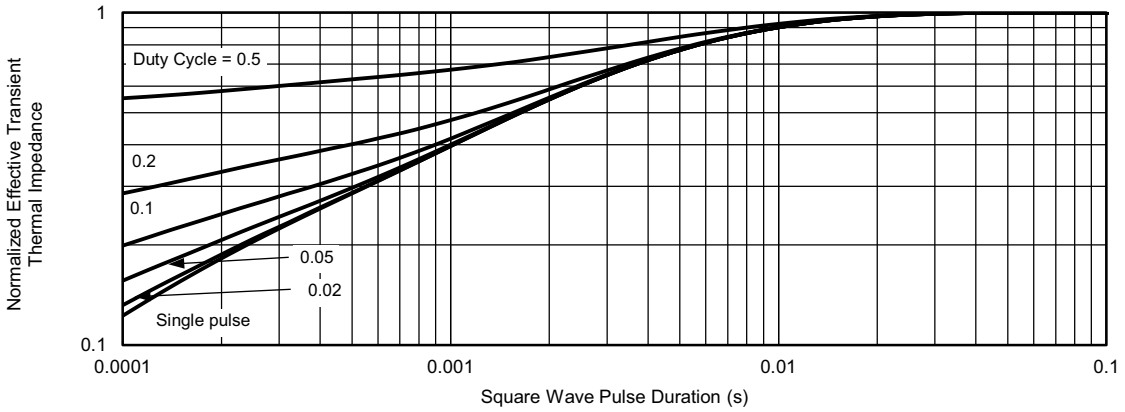


Normalized Thermal Transient Impedance, Junction-to-Ambient

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

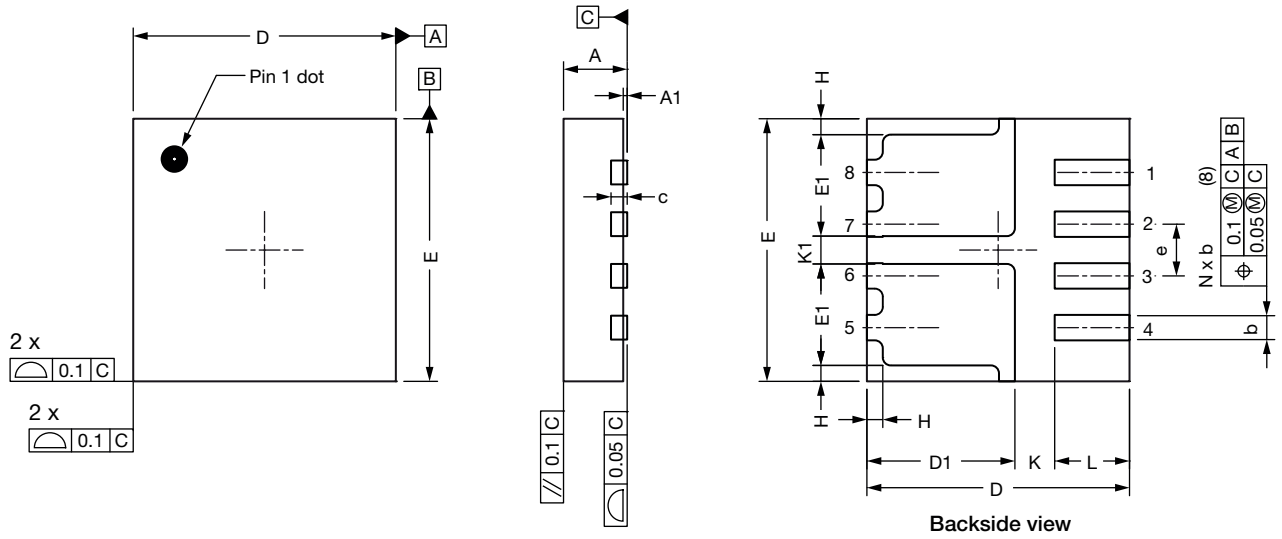


Normalized Thermal Transient Impedance, Junction-to-Case (Drain)

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PowerPAK® 1212-8S CD with Flip Chip

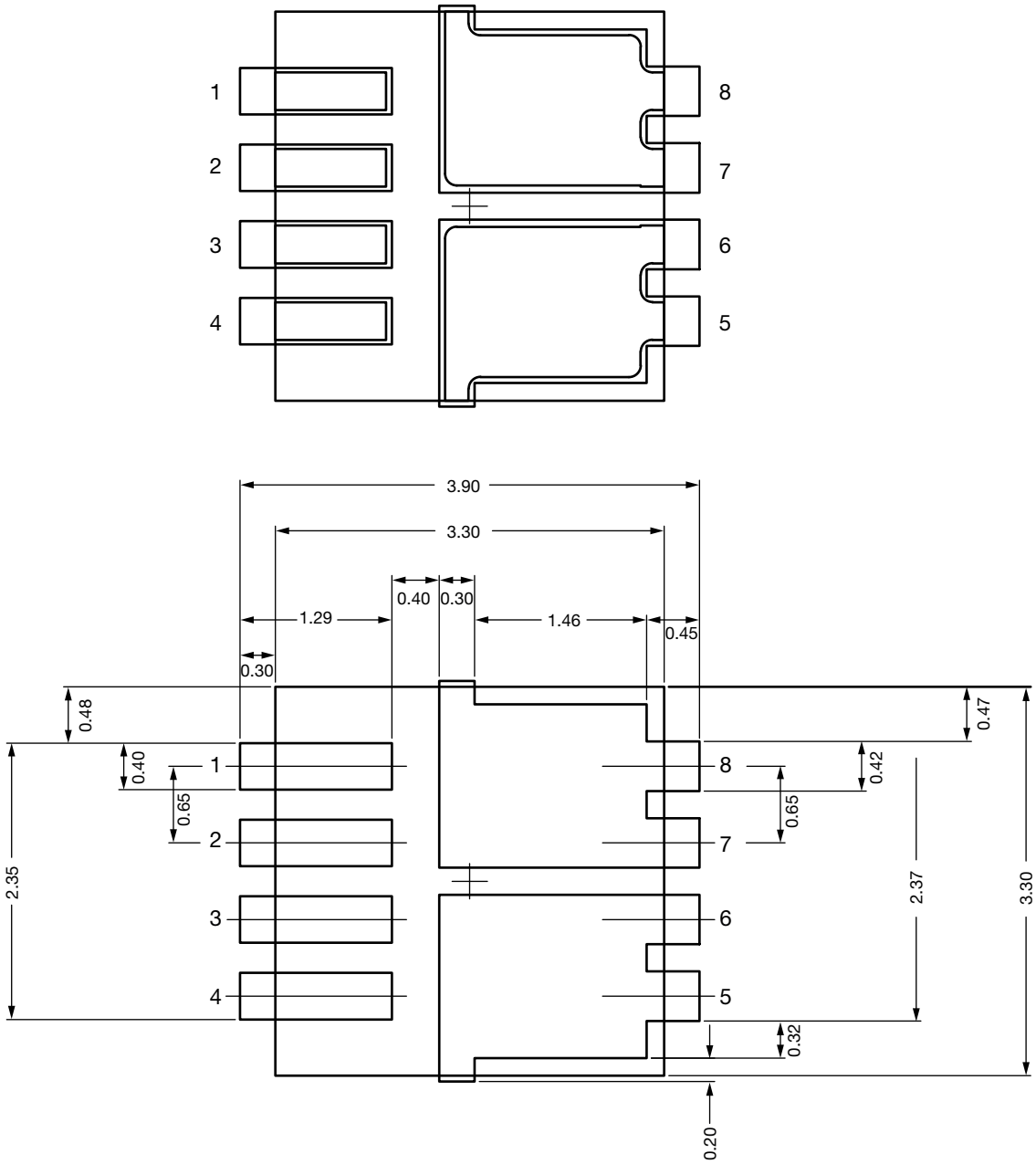


DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.70	0.75	0.80	0.027	0.029	0.031
A1	0	0.02	0.05	0	0.001	0.002
b	0.27	0.32	0.37	0.011	0.013	0.015
c	-	0.20 ref.	-	-	0.008 ref.	-
D	3.20	3.30	3.40	0.126	0.130	0.134
D1	1.76	1.86	1.96	0.069	0.073	0.077
E	3.20	3.30	3.40	0.126	0.130	0.134
E1	1.18	1.28	1.38	0.046	0.050	0.054
e	0.60	0.65	0.70	0.024	0.026	0.028
K	0.50 typ.			0.020 typ.		
K1	0.35 typ.			0.014 typ.		
H	0.10	0.20	0.30	0.006	0.008	0.010
L	0.84	0.94	1.04	0.033	0.037	0.041
ECN: C17-1732-Rev. A, 18-Dec-17 DWG: 6061						

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Recommended Land Pattern
PowerPAK® 1212-8S CD



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